

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and ovary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and easonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or una



FCP190N60 / FCPF190N60 N-Channel SuperFET[®] II MOSFET

600 V, 20.2 A, 199 m Ω

Features

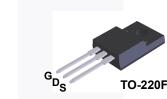
- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 170 mΩ
- Ultra Low Gate Charge (Typ. Q_q = 57 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 160 pF)
- 100% Avalanche Tested
- RoHS Compliant

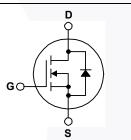
Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

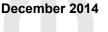
TO-220

Symbol		FCP190N60	FCPF190N60	Unit			
V _{DSS}	Drain to Source Voltage		6	V			
V _{GSS}	Cata ta Sauraa Valtaga	- DC		±	V		
	Gate to Source Voltage	- AC	(f > 1 Hz)	±	30	v	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		20.2	0.2 20.2*		
		- Continuous (T _C = 100 ^o C)		12.7	12.7*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)) 60.6 60.6*		Α	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	4	mJ		
I _{AR}	Avalanche Current		(Note 1)	4.0		Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	2.1		mJ	
dv/dt	MOSFET dv/dt			1	V/ns		
	Peak Diode Recovery dv/dt		(Note 3)	20		v/lis	
P _D	Device Dissingtion	$(T_{\rm C} = 25^{\rm o}{\rm C})$		208	39	W	
	Power Dissipation	- Derate Above 25°C		1.67	0.31	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C		

*Drain current limited by maximum junction temperature.

Thermal Characteristics

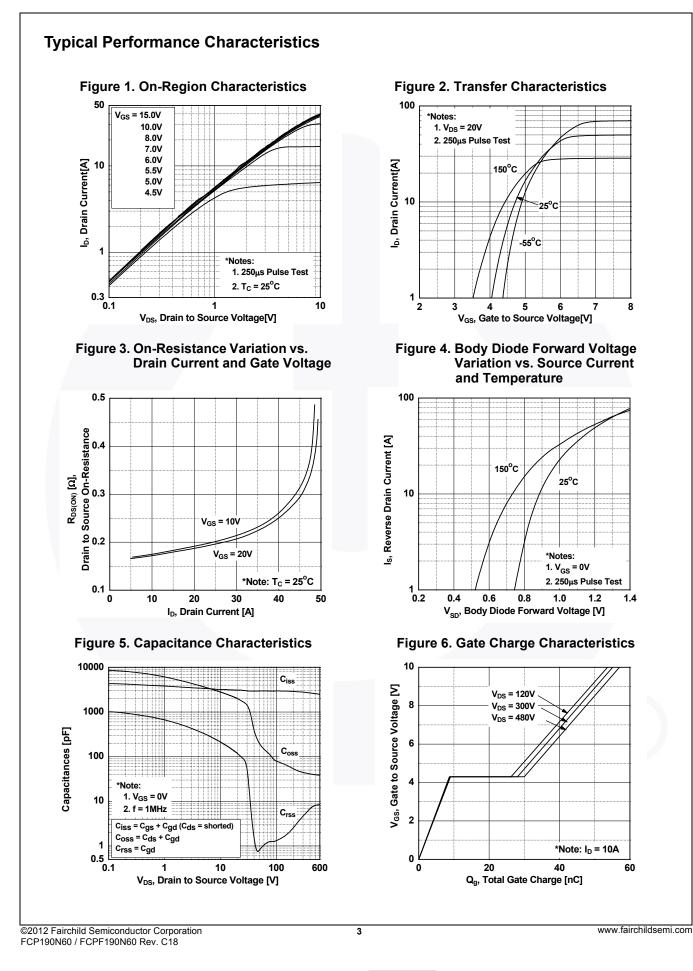
Symbol	Parameter	FCP190N60	FCPF190N60	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.6	3.2	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	C/W	

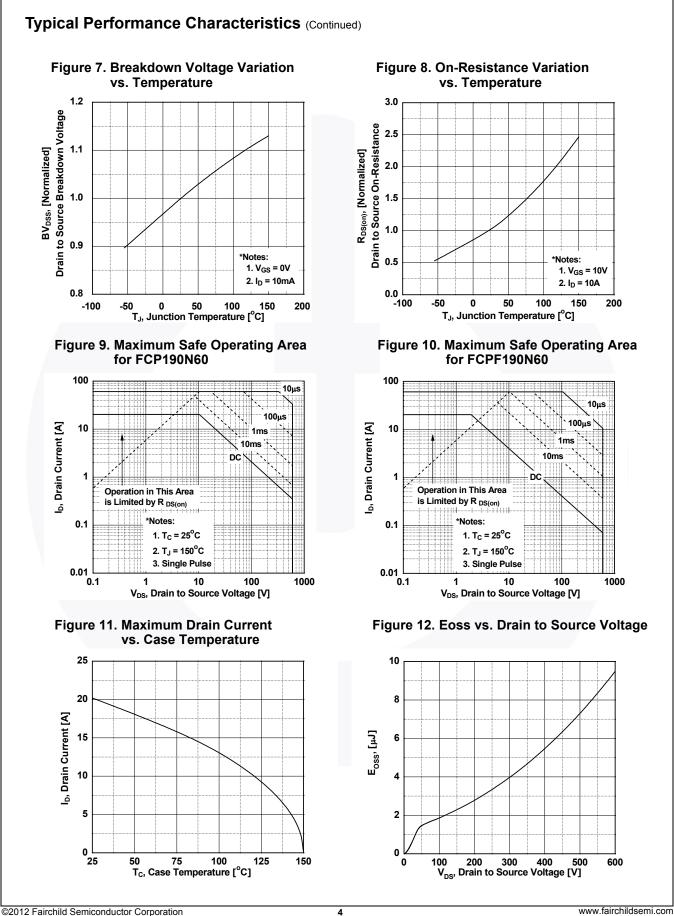


Part Number		Top Mark	Package	e Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCP190N60		FCP190N60	TO-220	Tube	N/A		N/A	50 units	
FCPF190	FCPF190N60 FCPF190N60 TC		TO-220F	Tube	N/A		N/A	50 units	
Electrica	l Chara	acteristics T _c = 25	^o C unless o	otherwise noted.					
Symbol		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics	5							
BV _{DSS}	Drain to Source Breakdown Voltage		20	V_{GS} = 0 V, I _D = 10 mA, T _J = 25°C		600	-	-	v
				V _{GS} = 0 V, I _D = 10 mA, T _J = 150°C		650	-	-	v
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient Drain to Source Avalanche Breakdown Voltage			I_D = 10 mA, Referenced to 25°C V_{GS} = 0 V, I_D = 20 A		-	0.67	-	V/ºC
BV _{DS}			down			-	700	-	V
I _{DSS}	Zero Ga	o Gate Voltage Drain Current		$V_{\rm DS}$ = 600 V, $V_{\rm GS}$ = 0 V		-	-	1	μA
				$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}$		-	1.3	-	
GSS	Gate to I	Body Leakage Current		$V_{GS} = \pm 20 V, V_{DS} = 0 V$		-	-	±100	nA
On Charac	teristics	;							
V _{GS(th)}	Gate Th	reshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA	`	2.5	-	3.5	V
R _{DS(on)}	Static Dr	ain to Source On Resista	ance	V _{GS} = 10 V, I _D = 10 A		-	0.17	0.199	Ω
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 10 A			21	-	S
Dynamic C	haracte	ristics							
C _{iss}	T	ut Capacitance					2220	2950	pF
C _{oss}		Capacitance		V _{DS} = 25 V, V _{GS} = 0 V f = 1 MHz		-	1630	2165	pF
C _{rss}		Transfer Capacitance				-	85	128	pF
C _{oss}		Capacitance		V _{DS} = 380 V, V _{GS} = 0 V	/ f = 1 MHz	-	42	-	pF
C _{oss(eff.)}		ive Output Capacitance Gate Charge at 10V		$V_{\rm DS} = 0 \text{ V to } 480 \text{ V}, V_{\rm GS} = 0 \text{ V}$		-	160	-	pF
Q _{g(tot)}						-	57	74	nC
Q _{gs}		Source Gate Charge		V _{DS} = 380 V, I _D = 10 A, V _{GS} = 10 V		-	9	_	nC
Q _{gd}		to Drain "Miller" Charge		(Note 4)		-	21	-	nC
ESR		alent Series Resistance		f = 1 MHz		-	1	-	Ω
Switching	Charact	oristics			i				
-							20	50	ns
t _{d(on)} t		urn-On Delay Time urn-On Rise Time		V _{DD} = 380 V, I _D = 10 A,			10	30	ns
t _r		Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)		-	64	138	ns
t _{d(off)} t _f		Fall Time					5	20	ns
					(1000 4)			20	113
Drain-Sou		e Characteristics							
l _S		Maximum Continuous Drain to Source Diode				-	-	20.2	A
I _{SM}		aximum Pulsed Drain to Source Diode Forward Current		1		-	-	60.6	A
V _{SD}		o Source Diode Forward Voltage		$V_{GS} = 0 V, I_{SD} = 10 A$		-	-	1.2	V
t _{rr}		Recovery Time		$V_{GS} = 0 V, I_{SD} = 10 A,$		-	320	-	ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt = 100 A/μs		-	5.1	-	μC

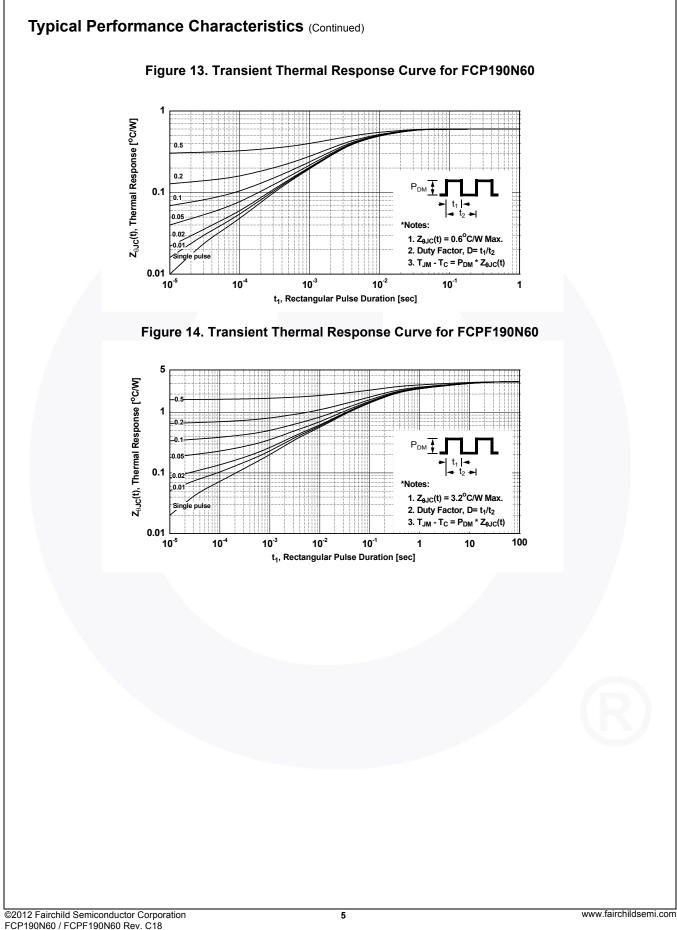
FCP190N60 / FCPF190N60 — N-Channel SuperFET[®] II MOSFET

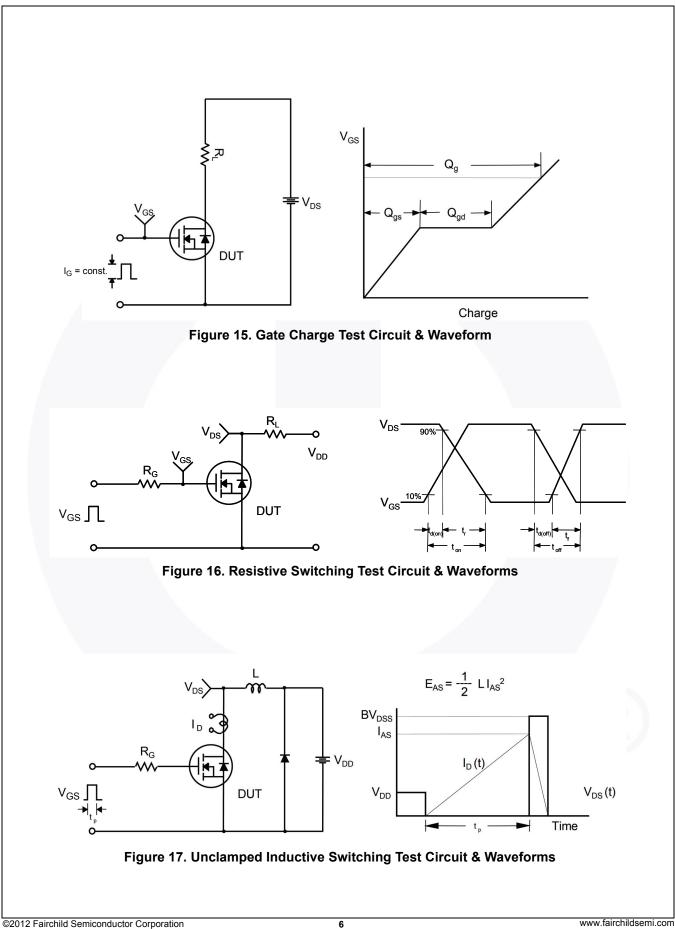




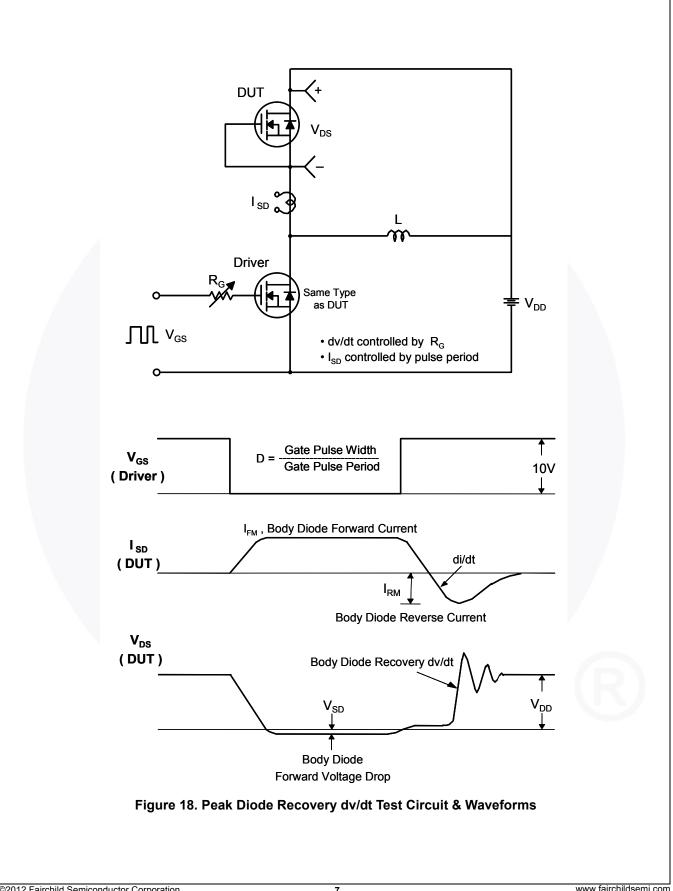


©2012 Fairchild Semiconductor Corporation FCP190N60 / FCPF190N60 Rev. C18

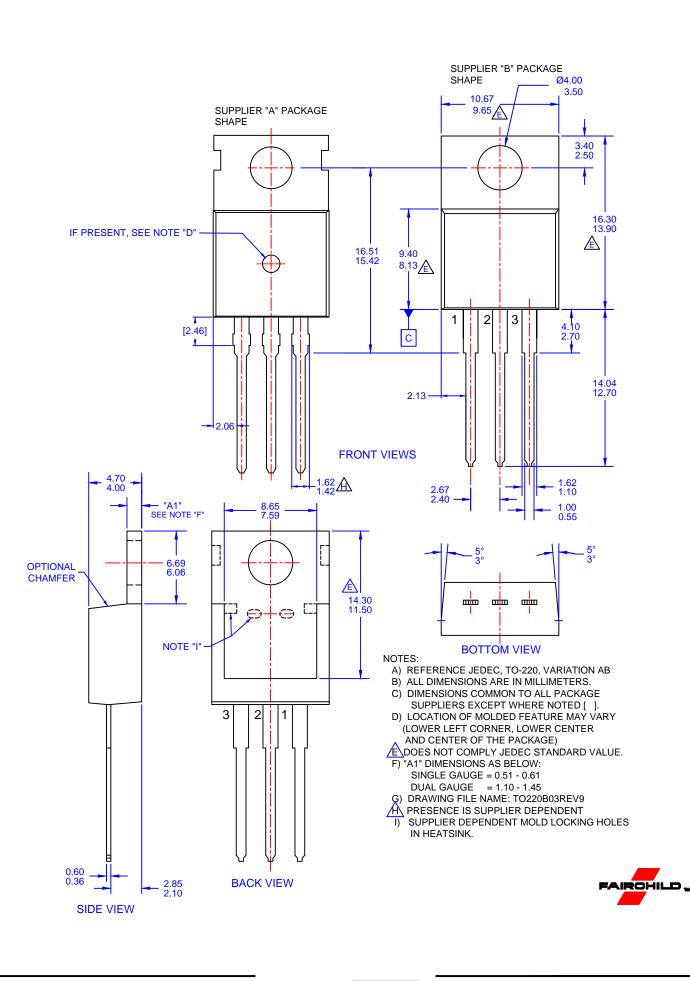


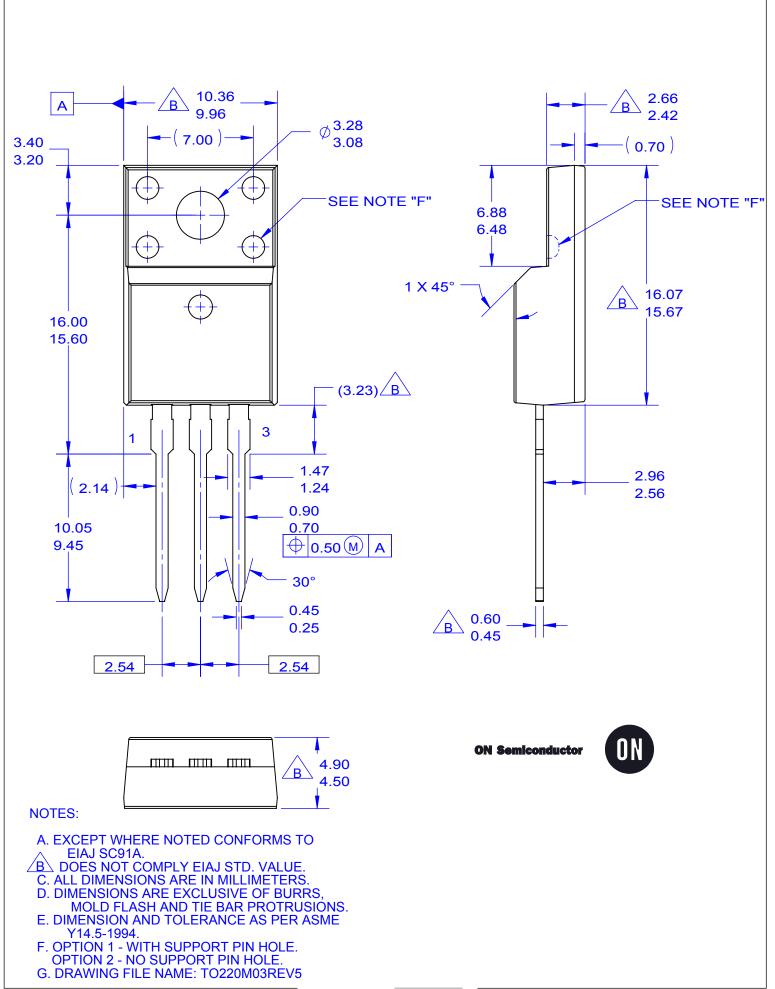


FCP190N60 / FCPF190N60 — N-Channel SuperFET[®] II MOSFET



FCP190N60 / FCPF190N60 — N-Channel SuperFET® II MOSFET





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

单击下面可查看定价,库存,交付和生命周期等信息

>>ON Semiconductor(安森美)